Form PTO1595 (Rev. 6-93) RECORDATION	COVER SHEET U.S. DEPARTMENT OF COMMERCE		
	PATENT AND TRADEMARK OFFICE  TS ONLY  ATTORNEY DOCKET NO.: HOYA0024		
To the Honorable Commissioner of Patents and Trademarks: Please rec	cord the attached original documents or copy thereof.		
Name of conveying part(ies):     Yukihiro TAKAHASHI and Kenichi SHINDE	Name and address of receiving party(ies)     Name: HOYA CORPORATION		
Additional Names(s) of conveying parties attached?   Yes   No	Internal Address:		
3. Nature of conveyance:	Street Address <u>7-5, Nakaochiai 2-chome,</u>		
☐ Security Agreement ☐ Change of Name	Shinjyu-ku, Tokyo 161-8525, Japan		
☐ Other	City: State: ZIP:		
Execution Date: October 10, 2000	Additional Name(s) & Addresses attached?		
If this document is being filed together with a new application, the  A. Patent Application No.(s)  10/259,635  Additional numbers	B. Patent No.(s) s attached? □ Yes ⊠ No		
5. Name and address of party to whom correspondence 6. Total number of applications and patents involved concerning document should be mailed:			
Name:Joerg-Uwe Szipl	7. Total fee (37 CFR 3.41)\$ 40.00		
Internal Address: Griffin & Szipl, PC	☐ Enclosed		
2300 Ninth Street, South	Authorized to be charged to deposit account		
Suite PH-1	9 Deposit account number:		
Street Address: same as above	8. Deposit account number.		
	501281		
City: <u>Arlington</u> State: <u>VA</u> ZIP: <u>22204</u>	(Attach duplicate copy of this page if paying by deposit account)		
DO NOT USE	ETHIS SPACE		
Statement and signature.     To the best of my knowledge and belief, the foregoing information is true an of the original document.	nd correct and any attached copy is a true copy		
Joerg-Uwe Szipl, Reg. No. 31,799 Name of Person Signing	August 19, 2003 Signatule Date		
	Signature Date ng cover sheat, attachments, and document:		

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments, Washington, D.C. 20231

For use only when this Assignment accompanies the appl cion papers and the application papers and this Assignment are signed by each respective inventor on the same date.

## ASSIGNMENT

WHEREAS, U	the undersigned (hereinafter As	signor) has made an
	THIN FILM FORMING METHOD AND APPARE	
	(Title of Invention)	
for which the undersigned	is about to make application for	Letters Patent of the
United States of America.	and which application is attach	date as shown by their
	ach of 1:he undersigned on the same	<b>uate 25 bil</b>
respective signatures belo		
WHEREAS	HOYA CORPORATION	
	(Name of Assignee)	i-ring under the laws of
(hereinafter Assignée), a	corporation duly organized and exi	lace of business at
Japan	and having its principal p	Tace of pusiness ac
(State or Count	:ry)	-
7-5. Nakaochiai 2-chome.	Shinjyu-ku, Tokyo 161-8525, Japan	
	(Address)	
	is desirous of acquirin	g an intérest therein:
NOW, THERE	FFORE, in consideration of One Do	ollar (\$1.00) and other
good and valuable conside	eration, the receipt and sufficien	ncy of which are hereby
acknowledged, the above-	said Assignor by these presents	does sell, assign and
transfer unto the said Ass	signee, its successors, assigns, an	d legal representatives.
	ght, title and interest to the said	
	all foreign countries, as descr	
application, and the Commi	issioner of Patents and Trademarks	is hereby authorized and
requested to issue said	Letters Patent to said Assigned	e, for its interest as
	assign: and legal representatives	
, per 1010111111	in the man	
Yukihiro TAKAHASHI	一髙梅女弘_	10. Oct. 2000
Typed Name	Signature	Date
Kenichi SHINDE	新女家一	10. Oct. 2000
Typed Name	Signature	Date
	Signature	
Typed Name		
Typed Name	Signature	Date
Typed Name	Signature	Date
Typed Name	Signature	Date

**PATENT REEL: 013889 FRAME: 0110** 

**RECORDED: 08/19/2003**